

M195XTN01.0

AU OPTRONICS CORPORATION

()	Preliminary Specification
(V	Final Specification

Module	19.5" Color TFT-LCD
Model Name	M195XTN01.0

Customer	Date	Approved by
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AU Optronics	corporation

.....1 document version 1.0



M195XTN01.0

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Record of Revision

Version	Date	Page	Old description	New Description	Remark
0.0	2013/10/17	All	First version release	-	
1.0	2013/12/20	5	2.1 Display Characteristics Weight: 1430	2.1 Display Characteristics Weight: 1380	
		14	3.2 Recommended Operating Condition=	Symbol: Description: Min. Typ. Max. Unit. Remark.	
		26	4.3.2 Recommended Operating Condition- (Ta-25°C) Symbol Description* Min. Typ. Max.* Unit 100% day state of LED	A.2. Recommended Operating Condition- Symbol Description Min. Typ. Max. Unit Remarks	
		27	Note 4-1: Vs (Typ.) = Vr, (Typ.) X LED No. (one string). a. Vr, LED chip forward voltage, Vr, (Min.) = 2 8V, Vr,(Typ.) = 3. Vr, Vr,(Max.) = 3. 4V,TBD). b. The same equation to calculate Vs(Min.) & Vs (Max.) for respective Vr, (Min.) & Vr,(Max.); + Vr LED chip LED chip	Note 4-f: Vs (Typ.) = V _F (Typ.) XLED No. (one string). a V _F LED chip forward voltage, V _F (Min.) ≥ 8V, V _F (Typ.) =3 TV, V _F (Max.) =3 4V· b. The same eugation to calculate Vs(Min.) & Vs (Max.) for respective V _F (Min.) & V _F (Max.). + V _F LED chip	
		30	Avoid towning COF position when dobg	Modify note description The destrict Constants The d	
		32	8.2 Pallet and shipment information	8.2 Pallet and shipment information-	
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1 Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open or modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) In case a TFT-LCD Module has to be put back into the packing container slot after once it was taken out from the container, do not press the center of the LED lightbar edge. Otherwise the TFT-LCD Module may be damaged.
- 10) Insert or pull out the interface connector, be sure not to rotate nor tilt it of the TFT-LCD Module.
- 11) Do not twist nor bend the TFT -LCD Module even momentary. It should be taken into consideration that no bending/twisting forces are applied to the TFT-LCD Module from outside. Otherwise the TFT-LCD Module may be damaged.
- 12) Please avoid touching COF position while you are doing mechanical design.
- 13) When storing modules as spares for a long time, the following precaution is necessary:

 Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5 and 35 at normal humidity.



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2 General Description

This specification applies to the 19.5 inch wide Color a-Si TFT-LCD Module M195XTN01.0. The display supports the HD - 1366(H) x 768(V) screen format and 16.7M colors (RGB 6-bits + Hi-FRC data). The input interface is 1-channel LVDS and this module doesn't contain an driver board for backlight.

2.1 Display Characteristics

The following items are characteristics summary on the table under 25 condition:

ITEMS	Unit	SPECIFICATIONS
Screen Diagonal	[mm]	493.92 (19.45")
Active Area	[mm]	434.0 (H) x 235.8 (V)
Pixels H x V	-	1366(x3) x 768
Pixel Pitch	[um]	317.7 (per one triad) ×307
Pixel Arrangement	-	R.G.B. Vertical Stripe
Display Mode	-	TN Mode, Normally White
White Luminance (Center)	[cd/m ²]	200 (Typ.)
Contrast Ratio	-	600 (Typ.)
Response Time	[msec]	5 (Typ., on/off)
Power Consumption	[Watt]	8.5 (Typ.)
(LCD Module + Backligh unit)		LCD module : PDD (Typ.)=2.5 @ Black pattern,Fv=60Hz
		Backlight unit : P _{BLU} (Typ.) =5.95 @Is=60mA
Weight	[Grams]	1380
Outline Dimension	[mm]	452(H) × 263(V) × 10.5(D) Typ.
Electrical Interface	-	1 channel LVDS
Support Color	-	16.7M colors (RGB 6-bit + Hi_FRC)
Surface Treatment	-	Anti-Glare, 3H
Temperature Range		
Operating	[°C]	0 to +50
Storage (Shipping)	[°C]	-20 to +60
RoHS Compliance	-	RoHS Compliance



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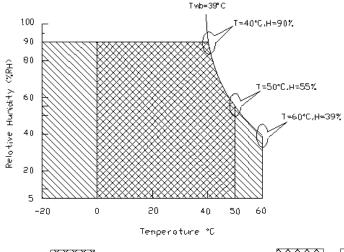
2.2 Absolute Maximum Rating of Environment

Permanent damage may occur if exceeding the following maximum rating.

Symbol	Description	Min.	Max.	Unit	Remark
TOP	TOP Operating Temperature		+50	[°C]	Note 2-1
TGS	Glass surface temperature (operation)	0	+65	[°C]	Note 2-1 Function judged only
HOP	HOP Operation Humidity		90	[%RH]	Note 2-1
TST Storage Temperature		-20	+60	[°C]	
HST	Storage Humidity	5	90	[%RH]	

Note 2-1: Temperature and relative humidity range are shown as the below figure.

- 1.90% RH Max (Ta 39)
- 2. Max wet-bulb temperature at 39 or less. (Ta 39)
- 3. No condensation



Operating Range



Storage Range



2.3 Optical Characteristics

The optical characteristics are measured on the following test condition.

Test Condition:

1. Equipment setup: Please refer to Note 2-2.

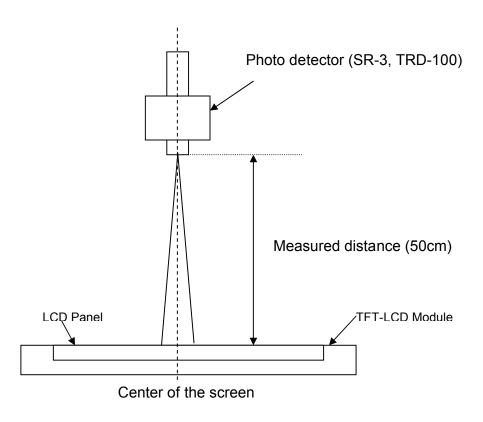
2. Panel Lighting time: 30 minutes

3. VDD=5.0V, Fv=60Hz,Is=60mA,Ta=25

Symbol	Descriptio	Description			Max.	Unit	Remark
L _w	White Luminance (Center of screen		160	200	-	[cd/m2]	Note 2-2 By SR-3
L _{uni}	Luminance Uniformit	y (9 points)	75	80	-	[%]	Note 2-3 By SR-3
CR	Contrast Ratio (Cente	er of screen)	360	600	-	-	Note 2-4 By SR-3
θ_{R}	Horizontal Viewing Angle	Right	35	45	-		-
θ_{L}	(CR=10)	Left	35	45	-		
Φ_{H}	Vertical Viewing Angle	Up	15	20	-		
Φ_{L}	(CR=10)	Down	40	45	-	[degree]	Note 2-5
θ_{R}	Horizontal Viewing Angle	Right	35	45	1		By SR-3
θ_{L}	(CR=5)	Left	35	45	-		
Φ_{H}	Vertical Viewing Angle	Up	15	20	-	_	
Φ_{L}	(CR=5)	Down	40	45	-		
T_R		Rising Time	-	3.8	5.5		
T_F	Response Time	Falling Time	-	1.2	2.5	[msec]	Note 2-6
-		Rising + Falling	-	5	8		By TRD-100
R_x		Red x	0.614	0.644	0.674		
R_y		Red y	0.303	0.333	0.363		
G _x		Green x	0.292	0.322	0.352		
Gy	Color Coordinates	Green y	0.593	0.623	0.653		
B _x	(CIE 1931)	Blue x	0.125	0.155	0.185	_	By SR-3
By		Blue y	0.028	0.058	0.088		
W _x		White x	0.283	0.313	0.343		
W _v		White y	0.299		0.359		
СТ	Crosstalk		-	-	1.5	[%]	Note 2-7 By SR-3
F _{dB}	Flicker (Center of	screen)	-	-	-20	[dB]	Note 2-8 By SR-3



Note 2-2: Equipment setup :

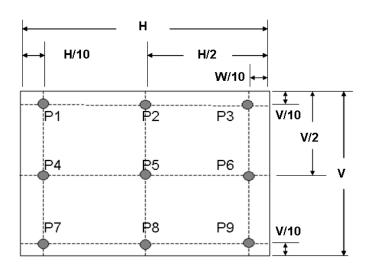


Note 2-3: Luminance Uniformity Measurement

Definition:

 $Luminance\ Uniformity = \frac{Minimum\ Luminance\ of\ 9\ Points\ (P1\sim P9)}{Maximum\ Luminance\ of\ 9\ Points\ (P1\sim P9)}$

a. Test pattern: White Pattern





Note 2-4: Contrast Ratio Measurement

Definition:

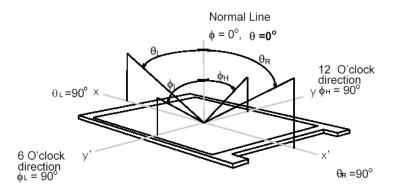
 $Contrast Ratio = \frac{Luminance of White pattern}{Luminance of Black pattern}$

a. Measured position: Center of screen (P5) & perpendicular to the screen ($\theta=\Phi=0^{\circ}$)

Note 2-5: Viewing angle measurement

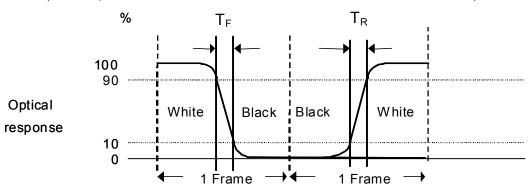
Definition: The angle at which the contrast ratio is greater than 10 & 5.

a. Horizontal view angle: Divide to left & right ($\theta_L \& \theta_R$) Vertical view angle: Divide to up & down ($\Phi_H \& \Phi_L$)



Note 2-6: Response time measurement

The output signals of photo detector are measured when the input signals are changed from "Black" to "White" (rising time, T_R), and from "White" to "Black" (falling time, T_F), respectively. The response time is interval between the 10% and 90% of optical response. (*Black & White color definition: Please refer section 3.4.3*)



Note 2-7: Crosstalk measurement

Definition:

 $CT = Max. (CT_H, CT_V);$

Where

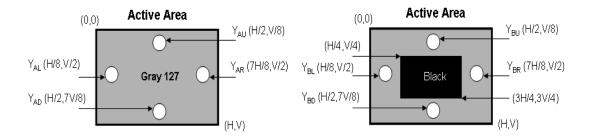
a. Maximum Horizontal Crosstalk:

$$CT_{H} = Max. (\mid Y_{BL} - Y_{AL} \mid / Y_{AL} \times 100 \%, \mid Y_{BR} - Y_{AR} \mid / Y_{AR} \times 100 \%);$$

Maximum Vertical Crosstalk:

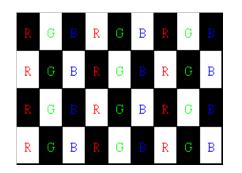
$$CT_V = Max. (|Y_{BU} - Y_{AU}|/Y_{AU} \times 100 \%, |Y_{BD} - Y_{AD}|/Y_{AD} \times 100 \%);$$

b. Y_{AU} , Y_{AD} , Y_{AL} , Y_{AR} = Luminance of measured location without Black pattern Y_{BU} , Y_{BD} , Y_{BL} , Y_{BR} = Luminance of measured location with Black pattern



Note 2-8: Flicker measurement

a. Test pattern: It is listed as following.



Gray level = L0

Gray level = L127

R: Red, G: Green, B:Blue

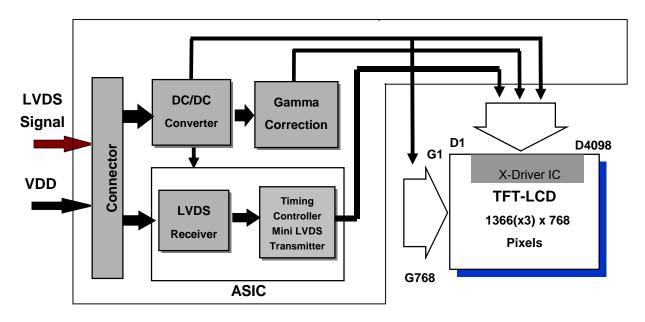
b. Measured position: Center of screen (P5) & perpendicular to the screen ($\theta=\Phi=0^{\circ}$)



3 TFT-LCD Module

3.1 Block Diagram

The following shows the block diagram of the 19.5 inch Color TFT-LCD Module.



Control Board



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3.2 Interface Connection

3.2.1 Connector Type

TFT-LCD Connector	Manufacturer	P-TWO	STM
	Part Number	AL230F-A0G1D-P	MSCKT2407P30HB
Mating Connector	Manufacturer	JAE	
I wating connector	Part Number	FI-X30HL (Locked Type)	

3.2.2 Connector Pin Assignment

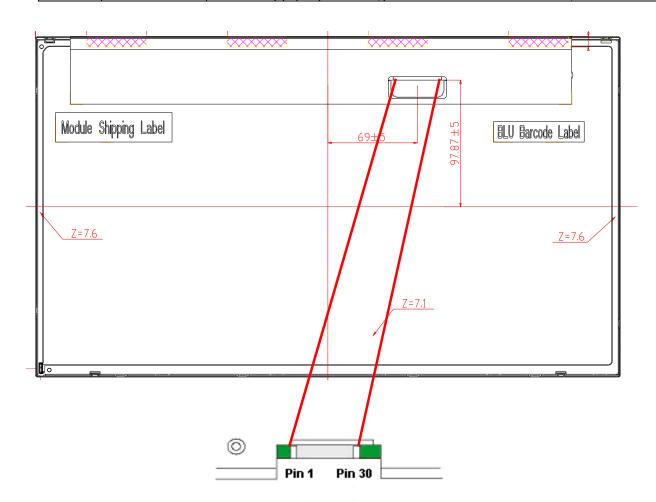
PIN#	Symbol	Description	Remark
1	NC	No connection	
2	NC	No connection	
3	NC	No connection	
4	NC	No connection	
5	NC	No connection	
6	NC	No connection	
7	GND	Ground	
8	NC	No connection	
9	NC	No connection	
10	NC	No connection	
11	NC	No connection	
12	RxIN0-	Negative LVDS differential data input	
13	RxIN0+	Positive LVDS differential data input	
14	GND	Ground	
15	RxIN1-	Negative LVDS differential data input	
16	RxIN1+	Positive LVDS differential data input	
17	GND	Ground	
18	RxIN2-	Negative LVDS differential data input	
19	RxIN2+	Positive LVDS differential data input	
20	RxCLKIN-	Negative LVDS differential clock input	
21	RxCLKIN+	Positive LVDS differential clock input	
22	RxIN3-	Negative LVDS differential data input	
23	RxIN3+	Positive LVDS differential data input	
24	NC	No connection (for AUO test only. Do not connect)	
25	NC	No connection (for AUO test only. Do not connect)	
26	NC	No connection (for AUO test only. Do not connect)	



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27	NC	No connection (for AUO test only. Do not connect)
28	VDD	Power Supply Input Voltage
29	VDD	Power Supply Input Voltage
30	VDD	Power Supply Input Voltage







3.3 Electrical Characteristics

3.3.1 Absolute Maximum Rating

Permanent damage may occur if exceeding the following maximum rating.

Symbol	Description	Min	Max	Unit	Remark
VDD	Power Supply Input Voltage	GND-0.3	6.0	[Volt]	Ta=25

3.3.2 Recommended Operating Condition

Symbol	Description	Min	Тур	Max	Unit	Remark
VDD	Power supply Input voltage	4.5	5.0	5.5	[Volt]	
IDD	Power supply	ı	0.5	0.6	[A]	VDD= 5.0V, Black Pattern, Fv=60Hz
טטו	Input Current (RMS)		0.6	0.7	[A]	VDD= 5.0V, Black Pattern, Fv=75Hz
PDD	VDD Power	ı	2.5	3.0	[Watt]	VDD= 5.0V, Black Pattern, Fv=60Hz
	Consumption		3.0	3.5	[Watt]	VDD= 5.0V, Black Pattern, Fv=75Hz
IRush	Inrush Current	-	-	3.0	[A]	Note 3-1
VDDrp	Allowable VDD Ripple Voltage	ı	-	500	[mV]	VDD= 5.0V, Black Pattern, Fv=75Hz

Note 3-1: Inrush Current measurement:

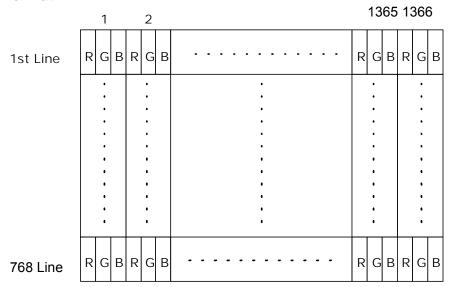
Test circuit: (Nigh to Low) Control Signal (LCD Module Input) (Nigh to Low) (Nigh to Low) (Nigh to Low) (Nigh to Low) (ADD Module Input) (ADD Module Input)

The duration of VDD rising time: 470us.

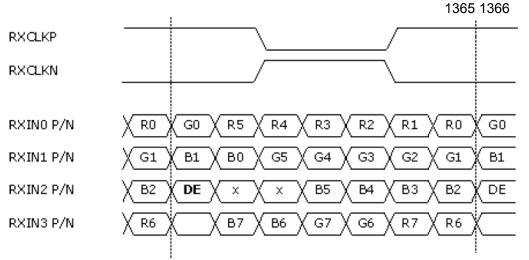
vod rising time-

3.4 Signal Characteristics

3.4.1 LCD Pixel Format



3.4.2 LVDS Data Format



001	8 BIT COLOR BIT ORDER								
MSB R7									
	R6								
	R5								
	R4								
	R3								
	R2								
	R1								
LSB	RO								

LVDS Data Mapping of NS Format

3.4.3 Color versus Input Data

The following table is for color versus input data (8bit). The higher the gray level, the brighter the color.

		Color Input Data																								
Color Gray Level		RED data (MSB:R7, LSB:R0)								N da , LSE)						E data)		Remark				
		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	В7	В6	B5	B4	ВЗ	В2	B1	В0	
Black	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
White	-	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
Gray 127	-	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	
	Ω	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Red					•••	• • •	•••	***	:	:	:		:	:	:	:	:		•••	:	:	:	:	:	:	
	L255	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Ш	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Green	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	
	Ш	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Blue	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	



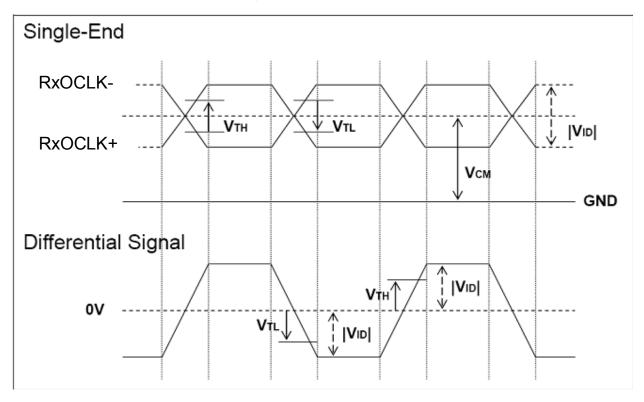
3.4.4 LVDS Specification

a. DC Characteristics:

Symbol	Description	Min	Тур	Max	Units	Condition
V_{TH}	LVDS Differential Input High Threshold	1	-	+100	[mV]	V _{CM} = 1.2V
V_{TL}	LVDS Differential Input Low Threshold	-100	-	-	[mV]	V _{CM} = 1.2V
V _{ID}	LVDS Differential Input Voltage	100	-	600	[mV]	
V _{CM}	LVDS Common Mode Voltage	+1.0	+1.2	+1.5	[V]	V_{TH} - V_{TL} = 200mV

LVDS Signal Waveform:

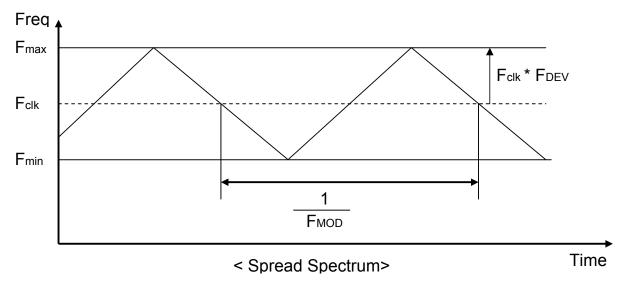
Use RxOCLK- & RxOCLK+ as example.





b. AC Characteristics:

Symbol	Description	Min	Max	Unit	Remark
F _{DEV}	Maximum deviation of input clock frequency during Spread Spectrum	-	± 3	%	
F _{MOD}	Maximum modulation frequency of input clock during Spread Spectrum	1	200	KHz	



Fclk: LVDS Clock Frequency



3.4.5 Input Timing Specification

It only support DE mode, and the input timing are shown as the following table.

Symbol	Descript	ion	Min.	Тур.	Max.	Unit	Remark
Tv		Period	793	808	1293	Th	
Tdisp (v)	Vertical Section	Active	768	768	768	Th	
Tblk (v)		Blanking	25	40	525	Th	
Fv		Frequency	50	60	76	Hz	
Th		Period	1454	1606	2047	Tclk	
Tdisp (h)	Horizontal Section	Active	1366	1366	1366	Tclk	
Tblk (h)		Blanking	88	240	681	Tclk	
Fh		Frequency	39.7	48.5	64.6	KHz	Note 3-3
Tclk	LVDS Clock	Period	10.6	12.8	17.3	ns	1/Fclk
Fclk	2123 SIGGR	Frequency	57.7	77.9	94.0	MHz	Note 3-4

Note 3-3: The equation is listed as following. Please don't exceed the above recommended value.

Fh (Min.) = Fclk (Min.) / Th (Min.); Fh (Typ.) = Fclk (Typ.) / Th (Typ.);

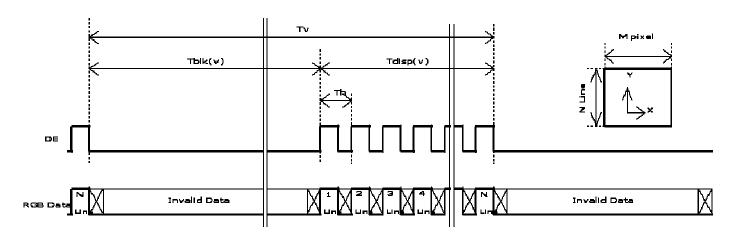
Fh (Max.)= Fclk (Max.) / Th (Min.);

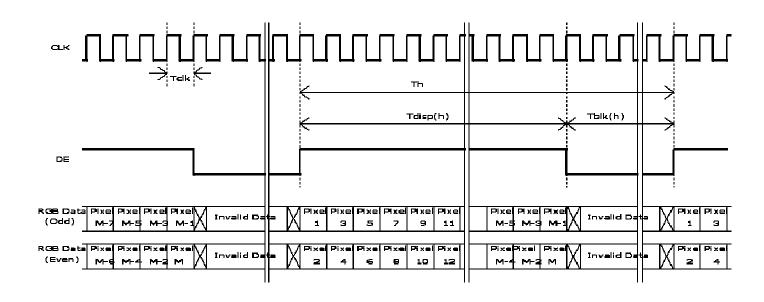
Note 3-4: The equation is listed as following. Please don't exceed the above recommended value.

Fclk (Min.) = Fv (Min.) x Th (Min.) x Tv (Min.); Fclk (Typ.) = Fv (Typ.) x Th (Typ.) x Tv (Typ.);

Fclk (Max.) = Fv (Max.) x Th (Typ.) x Tv (Typ.);

3.4.6 Input Timing Diagram

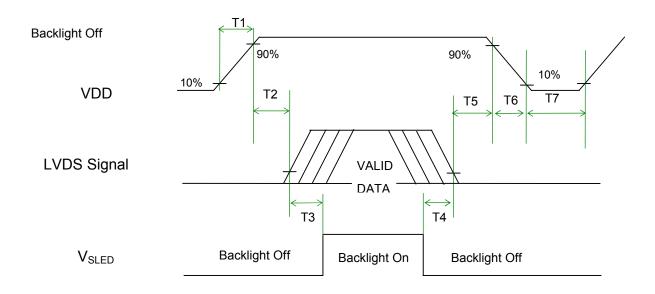






3.5 Power ON/OFF Sequence

VDD power,LVDS signal and backlight on/off sequence are as following. LVDS signals from any system shall be Hi-Z state when VDD is off.



Power Sequence Timing

Symbol		Value		I I m i f	Remark		
Symbol	Min.	Тур.	Max.	Unit			
T1	0.5	-	10	[ms]			
T2	0	-	50	[ms]			
T3	500	-	-	[ms]			
T4	100	-	-	[ms]			
T5	0		50	[ms]	Note 3-5 Note 3-6		
T6	0	-	150	[ms]	Note 3-6		
T7	1000	-	-	[ms]			

Note 3-5: Recommend setting T5 = 0ms to avoid electronic noise when VDD is off.

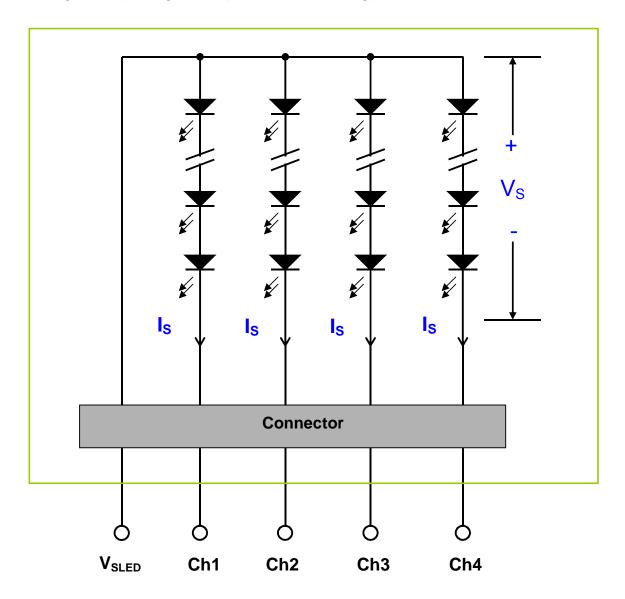
Note 3-6: During T5 and T6 period, please keep the level of input LVDS signals with Hi-Z state.



4 Backlight Unit

4.1 Block Diagram

The following shows the block diagram of the 19.5 inch Backlight Unit. And it includes 32 pcs LED in the LED light bar. (4 strings and 8 pcs LED of one string).





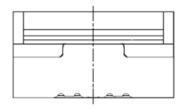
4.2 Interface Connection

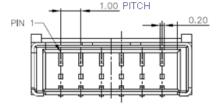
4.2.1 Connector Type

Backlight Connector	Manufacturer	ENTERY				
Bucklight Confector	Part Number	3707K-S06N-21R				
Mating Connector	Manufacturer	ENTERY				
Mating Connector	Part Number	H112K-P06N-13B (Locking type)				

Backlight Connector dimension:

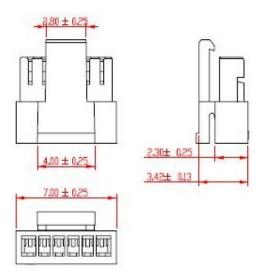
$$H \times V \times D = 13.9 \times 3.00 \times 4.25$$
, $Pitch = 1.0(unit = mm)$

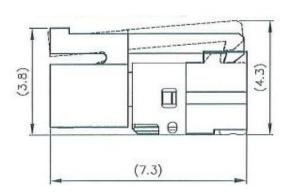






Mating Connector dimension:



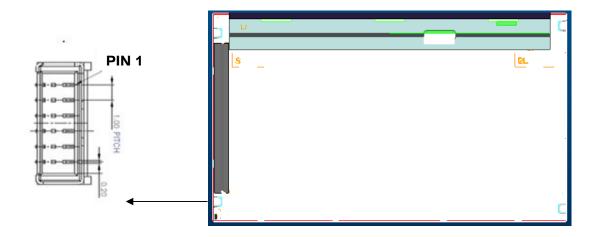




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4.2.2 Connector Pin Assignment

Pin#	Symbol	Description	Remark
1	Ch1	LED Current Feedback Terminal (Channel 1)	
2	Ch2	LED Current Feedback Terminal (Channel 2)	
3	V_{SLED}	LED Power Supply Voltage Input Terminal	
4	V_{SLED}	LED Power Supply Voltage Input Terminal	
5	Ch3	LED Current Feedback Terminal (Channel 3)	
6	Ch4	LED Current Feedback Terminal (Channel 4)	



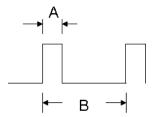
4.3 Electrical Characteristics

4.3.1 Absolute Maximum Rating

Permanent damage may occur if exceeding the following maximum rating.

(Ta=25)

Symbol	Description	Min	Max	Unit	Remark
	LED String Current		90	[mA]	100% duty ratio
Is		0	150	[mA]	Duty ratio 10% Pulse time=10 ms



Duty ratio= (A / B) X 100%; (A: Pulse time, B: Period)

4.3.2 Recommended Operating Condition

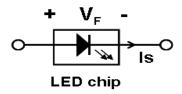
(Ta=25

Symbol	Description	Min.	Тур.	Max.	Unit	Remark
ls	LED String Current	-	60	66	[mA]	100% duty ratio of LED chip
Vs	LED String Voltage	22.4	24.8	27.2	[Volt]	Is=60mA @ 100% duty ratio; <i>Note 4-1, Note 4-5</i>
ΔVs	Maximum Vs Voltage Deviation of light bar	-	-	1.6	[Volt]	Is=60mA @ 100% duty ratio; <i>Note 4-2</i>
P _{BLU}	LED Light Bar Power Consumption	-	5.95	6.5	[Watt]	Note 4-3
LT _{LED}	LED Life Time	30,000	-	-	[Hour]	Note 4-4
OVP	Over Voltage Protection in system board	110% Vsmax	-	-	[Volt]	Note 4-5

M195XTN01.0

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- **Note 4-1:** Vs (Typ.) = V_F (Typ.) X LED No. (one string);
 - a. V_F: LED chip forward voltage, V_F (Min.)=2.8V, V_F(Typ.)=3.1V, V_F(Max.)=3.4V
 - b. The same euqation to calculate Vs(Min.) & Vs (Max.) for respective V_F (Min.) & V_F (Max.);



- **Note 4-2:** ΔVs (Max.) = $\Delta V_F X$ LED No. (one string);
 - a. $\Delta V_{F:}$ LED chip forward voltage deviation; (0.2 V , each Bin of LED V_F)
- **Note 4-3:** P_{BLU} (Typ.) = Vs (Typ.) X Is (Typ.) X 4; (4 is total String No. of LED Light bar) P_{BLU} (Max.) = Vs (Max.) X Is (Typ.) X 4;
- **Note 4-4:** Definition of life time:
 - a. Brightness of LED becomes to 50% of its original value
 - b. Test condition: Is = 60mA and 25 (Room Temperature)
- **Note 4-5:** Recommendation for LED driver power design:

Due to there are electrical property deviation in LED & monitor set system component after long time operation. AUO strongly recommend the design value of LED driver board OVP (over voltage protection) should be 10% higher than max. value of LED string voltage (Vs) at least.

Note 4-6: AUO strongly recommend "Analog Dimming" method for backlight brightness control for Wavy Noise Free. Otherwise, recommend that Dimming Control Signal (PWM Signal) should be synchronized with Frame Frequency.

5 Reliability Test

AUO reliability test items are listed as following table. (Bare Panel only)

Items	Condition	Remark	
Temperature Humidity Bias (THB)	Ta= 50 , 80%RH, 300hours		
High Temperature Operation (HTO)	Ta= 50 , 50%RH, 300hours		
Low Temperature Operation (LTO)	Ta= 0 , 300hours		
High Temperature Storage (HTS)	Ta= 60 , 300hours		
Low Temperature Storage (LTS)	Ta= -20 , 300hours		
Vibration Test (Non-operation)	Acceleration: 1.5 Grms Wave: Random Frequency: 10 - 200 Hz Sweep: 30 Minutes each Axis (X, Y, Z)		
Shock Test (Non-operation)	Acceleration: 50 G Wave: Half-sine Active Time: 20 ms Direction: ±X, ±Y, ±Z (one time for each Axis)		
Thermal Shock Test (TST)	-20 /30min, 60 /30min, 100 cycles	Note 5-1	
On/Off Test	On/10sec, Off/10sec, 30,000 cycles		
ESD (Electro Static Discharge)	Contact Discharge: \pm 15KV, 150pF(330 Ω) 1sec, 8 points, 25 times/ point.	- Note 5-2	
	Air Discharge: ± 15KV, 150pF(330Ω) 1sec 8 points, 25 times/ point.		
Altitude Test	Operation:18,000 ft Non-Operation:40,000 ft		

- **Note 5-1**: a. A cycle of rapid temperature change consists of varying the temperature from -20 to 60 , and back again. Power is not applied during the test.
 - b. After finish temperature cycling, the unit is placed in normal room ambient for at least 4 hours before power on.

Note 5-2: EN61000-4-2, ESD class B: Certain performance degradation allowed

No data lost Self-recoverable No hardware failures.

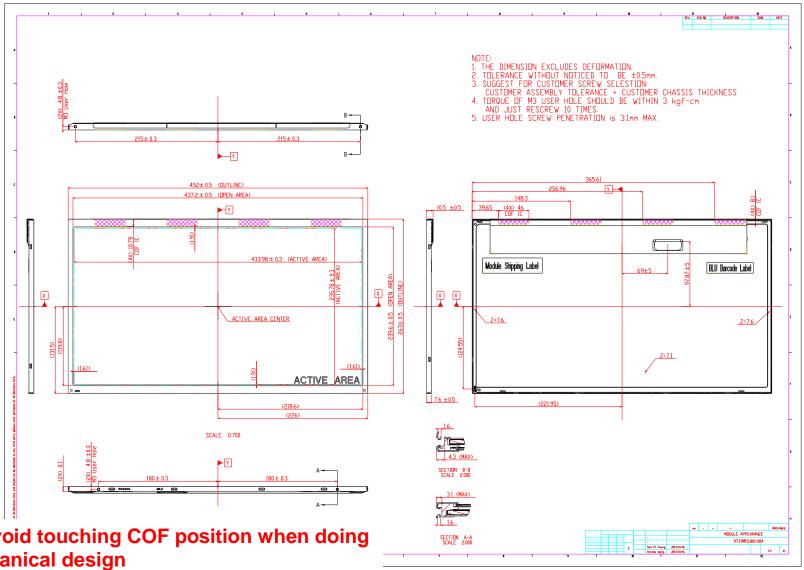
6 Shipping Label

The label is on the panel as shown below:



- Note 6-1: For Pb Free products, AUO will add 🕲 for identification.
- Note 6-2: For RoHS compatible products, AUO will add RoHS for identification.
- Note 6-3: For China RoHS compatible products, AUO will add 6 for identification.
- **Note 6-4:** The Green Mark will be presented only when the green documents have been ready by AUO Internal Green Team.

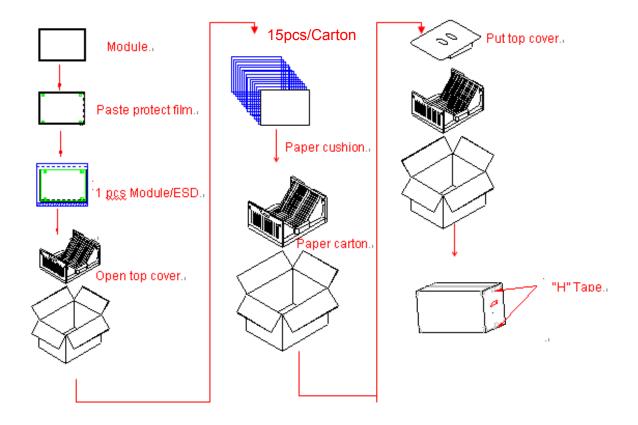
7 Mechanical Characteristics

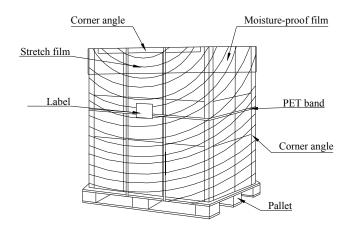


- (1) Avoid touching COF position when doing mechanical design
- (2) The user hole depth of the light bar side is different from the other side

8 Packing Specification

8.1 Packing Flow





8.2 Pallet and shipment information

Item	Specification			Remark
	Q'ty	Dimension	Weight(kg)	Remark
Panel	1	452.0(H)mmx263(V)mmx10.5(D)mm	1.38 Kg	
Cushion	1	-	2 Kg	
Вох	1	526(L)mm x 299(W)mm x 335(H)mm	0.7Kg	without Panel & cushion
Packing Box	15 pcs/Box	526(L)mm x 299(W)mm x 335(H)mm	24.15Kg	with panel & cushion
Pallet	1	1150(L)mm x 910(W)mm x 138(H)mm	15Kg	
Pallet after Packing	18boxes/ pallet	1150(L)mm x 910(W)mm x 1143(H)mm	449.7Kg	